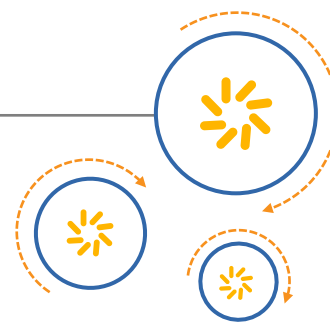




Qualcomm Technologies, Inc.



# **QCA6234 Integrated Dual-Band 2x2 802.11n + Bluetooth® 4.0**

## **Data Sheet**

September 2016

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| A        | June 1, 2015   | Initial release     |

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# 1 Introduction

## 1.1 General description

The QCA6234 chip is a complete, small form factor 2x2 802.11 a/b/g/n WLAN plus BT4.0 combo solution optimized for low-power embedded devices. The device integrates all WLAN and Bluetooth® (BT) functionality in a single package to support a low cost, layout-friendly implementation while allowing flexibility for platform specific customization.

The QCA6234 chip integrates the complete transmit/receive RF paths including baluns, switches, and a reference oscillator. The device is also pre-calibrated, eliminating the need for customer production calibration.

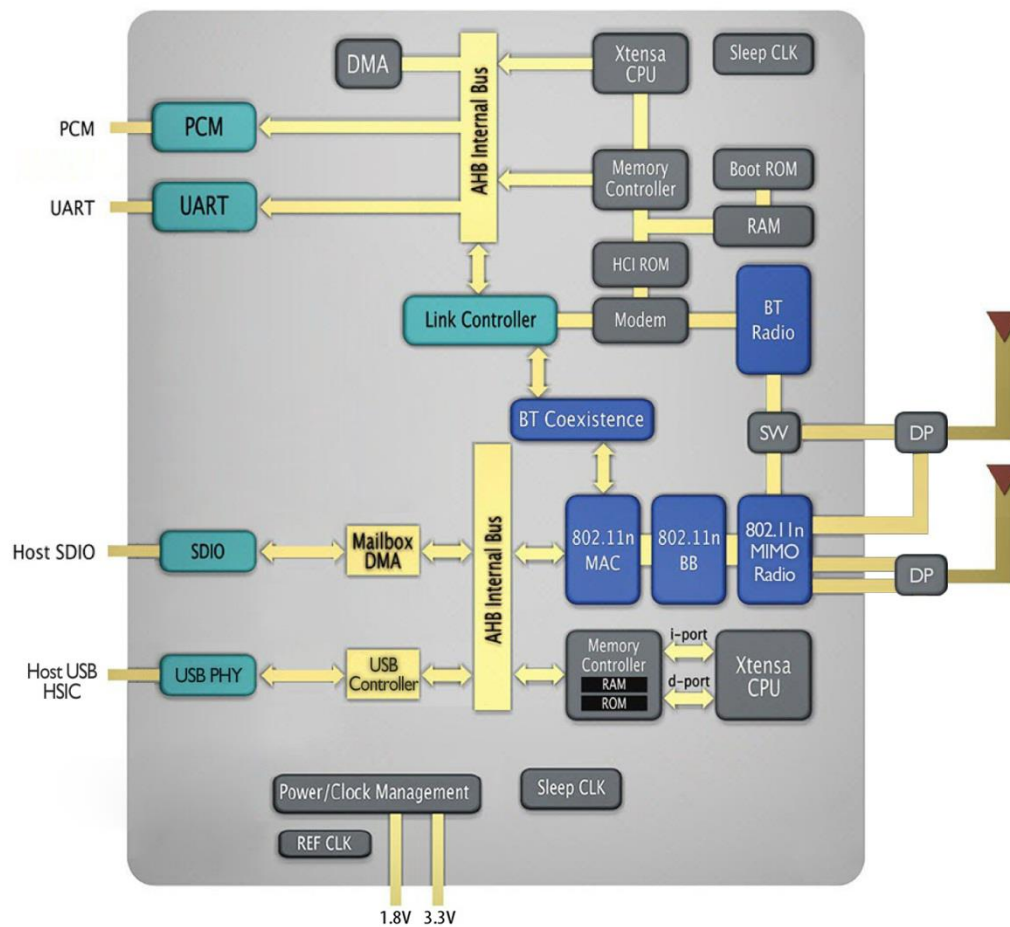


Figure 1-1 QCA6234 system block diagram

QCA6234 supports Bluetooth 2.1 + EDR and Bluetooth low energy (Bluetooth 4.0) standards enabling seamless integration of BT/WLAN and Low Energy technology. A flexible BT RAM/ROM split architecture enables optional customization to meet customer specific needs and use cases. Ultra-low power consumption radio architecture and proprietary power save technologies extend battery life. Embedded on-chip CPUs handle complete 11n and BT MAC/BB/PHY processing to minimize host processor loading.

QCA6234 is available in three variants:

- QCA6234X: 2x2, dual-band 802.11n and Bluetooth 4.0 (SDIO)
- QCA6234XH: 2x2, dual-band 802.11n and Bluetooth 4.0 (HSIC)
- QCA6234XU: 2x2, dual-band 802.11n and Bluetooth 4.0 (USB)

QCA6234 is available in a low profile 9.2 mm x 9.2 mm LGA package with 0.65 mm pitch pads for low-cost PCB design. It is halogen-free, Pb-free, and fully ROHS compliant.

**NOTE:** This document provides a description of chipset capabilities. Not all features are available, nor are all features supported in the software.

**NOTE:** Enabling some features may require additional licensing fees.

## 1.2 Acronyms, abbreviations, and terms

Table 1-1 provides definitions for the acronyms, abbreviations, and terms used in this document.

**Table 1-1 Acronyms, abbreviations, and terms**

| Term  | Definition                          |
|-------|-------------------------------------|
| A2DP  | Advanced Audio Distribution Profile |
| ADB   | Android Debug Bridge                |
| ADC   | Analog-to-Digital Converter         |
| ACL   | Access Control List                 |
| AHB   | Advanced High-Performance Bus       |
| ANT   | Antenna                             |
| AP    | Access Point                        |
| APB   | Advanced Peripheral Bus             |
| ARP   | Address Resolution Protocol         |
| ATPG  | Automatic Test Procedure            |
| AVRCP | Audio/video Remote Control Profile  |
| BB    | Baseband                            |
| BPSK  | Binary Phase Shift Keying           |
| BT    | Bluetooth                           |
| CODEC | Coder-Decoder                       |
| DCU   | DCF control units                   |
| DMA   | Direct Memory Access                |
| DRU   | DMA Receive Unit                    |

| Term | Definition                                 |
|------|--------------------------------------------|
| DTIM | Delivery Traffic Indication Map            |
| EDR  | Enhanced Data Rate                         |
| ESD  | Electrostatic Discharge                    |
| EVM  | Error Vector Magnitude                     |
| FTP  | File Transfer Protocol                     |
| GAP  | Generic Access Profile                     |
| HFP  | Hands Free Profile                         |
| HGI  | Half Guard Interval                        |
| HID  | Human Interface Device                     |
| HIU  | Host Interface Unit                        |
| HGI  | Half Guard Interval                        |
| HSP  | Head Set Profile                           |
| LDPC | Low Density Parity Check                   |
| LTE  | Long Term Evolution                        |
| MAC  | Message Authentication Code                |
| Mbps | Megabits Per Second                        |
| ML   | Minimum Likelihood                         |
| MPDU | Mac Protocol Data Unit                     |
| MRC  | Maximum Ratio Combining                    |
| MSDU | MAC Service Data Unit                      |
| OFDM | Orthogonal Frequency Division Multiplexing |
| OPP  | Object Push Profile                        |
| PA   | Power Amplifier                            |
| PAN  | Personal Area Network                      |
| PCB  | Printed Circuit Board                      |
| PCU  | Protocol Control Unit                      |
| PCM  | Pulse Code Modulation                      |
| PD   | Pull Down                                  |
| PHY  | Physical Layer                             |
| PIF  | Peripheral Interface                       |
| PMK  | Pairwise Master Key                        |
| PU   | Pull Up                                    |
| QCU  | Queue Control Unit                         |
| QoS  | Quality Of Service                         |
| RF   | Radio Frequency                            |
| RH   | Relative Humidity                          |
| RIFS | Reduced Inter-frame Spacing                |
| RTC  | Reverse Traffic Channel                    |
| RTT  | Round Trip Time                            |

| Term    | Definition                                  |
|---------|---------------------------------------------|
| RX (Rx) | Receiver                                    |
| SI      | System Information                          |
| SIP     | Simple IP                                   |
| SDIO    | Secure Digital Input Output                 |
| SPI     | Serial Peripheral Interface                 |
| SPP     | Serial Port Protocol                        |
| STBC    | Space Time Block Coding                     |
| TCP     | Transmit Control Protocol                   |
| TX (Tx) | Transmitter                                 |
| UART    | Universal Asynchronous Receiver Transmitter |
| uHAST   | Unbiased Highly Accelerated Stress Test     |
| VOIP    | Voice Over Internet Protocol                |
| WEP     | Wired Equivalent Privacy                    |
| WLAN    | Wireless Local Area Network                 |
| WMM     | Wi-Fi Multimedia                            |
| WPA     | Wi-Fi Protected Access                      |
| WPS     | WLAN Protected Setup                        |

## 1.3 QCA6234 features

- Two stream (2x2) 802.11n provides highest throughput and superior RF performance for embedded computing devices.
- Advanced 2x2 802.11n features:
  - 40 MHz channels at 5 GHz
  - Half guard interval (HGI) for high throughput
  - Frame aggregation for high throughput
  - Space time block coding (STBC) Rx for improved downlink robustness over range
  - Low density parity check (LDPC) encoding for improved uplink and downlink robustness over range
  - Maximum ratio combining (MRC)
  - Maximum likelihood (ML) decoder
- Supports popular interfaces used in embedded designs:
  - SDIO 2.0 (50 MHz, 4-bit and 1-bit) for WLAN
  - USB/HSIC for WLAN
  - High-speed UART (up to 4 Mbps)
- Bluetooth™ low energy (BT4.0) ready.
  - Class 1.5 Bluetooth with integrated Tx/Rx switch

- All WLAN RF transmitters are pre-calibrated.
- Near zero power consumption in idle and stand-by enables users to leave WLAN and BT *always on*.
- Advanced BT/WLAN coexistence and concurrent RX for superior rate-over-range and very low latency.
- Best in class Rx sensitivity for superior throughput rate-over-range performance.
- Integrated Sleep Clock eliminates the need for expensive bulky 32 KHz real-time clock.
- Integrated conformal RF shielding and near-zero RBOM for lowest cost.

# 2 Features Summary

---

## 2.1 Overview

The QCA6234 chip is a single package combination IEEE 802.11 a/b/g/n plus Bluetooth 4.0 device based on cutting edge technology from the AR6004 ROCm family of mobile 11n and AR3002 ROCm family of HCI-ROM Bluetooth devices. The QCA6234 contains dual 802.11 and Bluetooth radios, including full digital MAC and baseband engines handling all 802.11 CCK/OFDM 2.4 GHz, and Bluetooth basic rate, and EDR baseband and protocol processing. Dual embedded low-power CPU cores minimize host loading and maximize flexibility to support customer specific profiles and use cases.

## 2.2 Radio front end

The QCA6234 integrates the complete transmit/receive RF paths including baluns, switches, and reference oscillator. External diplexers are required for dual-band WLAN implementation.

## 2.3 Industry leading coexistence

The QTI proprietary WLAN/BT coexistence algorithms, proven in various devices and portable devices shipped-to-date, are designed to enable superior rate-over-range throughput and low-latency performance in various operating conditions.

The algorithms optimize important use cases such as Bluetooth monovoice audio (HSP/HFP), Bluetooth stereo audio (A2DP), and Bluetooth data transfer profiles (OPP, FTP, etc.) in parallel with WLAN traffic including concurrent operation of BT2.1+EDR and BT-LE cases.

The use cases are optimized to provide the highest WLAN throughput, long range, and low power consumption while maintaining excellent Bluetooth audio quality, high data throughput, and low-latency. The flexible hardware and software architecture of the QCA6234 is also designed to help deployment of customization and enhancements of the coexistence algorithm to support any future use cases.

## 2.4 Power management

The QCA6234 can run on one 3.3 volt power supply and an I/O supply of 1.8V. Both WLAN and Bluetooth power management utilize advanced power saving techniques such as: gating clocks to idle or inactive blocks; voltage scaling to specific blocks in certain states; fast start and settling circuits to reduce Tx; active duty cycles, CPU frequency scaling, and other techniques to optimize power consumption across all operating states.

QCA6234X and QCA6234XH versions are designed to use the internal 1.2V switching regulator. However, QCA6234XU version must use an external 1.2V supply for both the analog and digital 1.2V domain.

## 2.5 Manufacturing calibration

The QCA6234 is fully RF system tested and calibrated in production, simplifying the radio testing on the customer production line, and eliminating the need for calibration.

## 2.6 Reference frequency

The QCA6234 incorporates a 26 MHz reference frequency source in-package. Internally, the system reference frequency is sleep regulated and gated to enable the internal crystal to be powered down when the device is in sleep mode. Manufacturing calibration of the crystal is not required.

## 2.7 Internal sleep clock

The QCA6234 incorporates integrated on-chip low power sleep clocks to regulate internal timing, eliminating the need for any external 32 KHz real-time clocks or crystal oscillators.

## 2.8 Interfaces

The QCA6234 supports industry standard WLAN and Bluetooth host interfaces:

- SDIO 2.0 (50 MHz, 4-bit and 1-bit) for WLAN
- USB/HSIC for WLAN
- HS-UART for Bluetooth HCI (Host Controller Interface) and is compatible with any upper layer Bluetooth stack

## 2.9 Mobile 802.11n

The QCA6234 incorporates the latest generation of mobile 802.11n technology from QTI. The QCA6234 is 802.11n compliant and features:

- Half Guard Interval for high throughput
- Frame Aggregation for high throughput
- Space Time Block Coding (STBC) Rx for improved downlink robustness over range
- Low Density Parity Check (LDPC) for improved uplink and downlink robustness over range

[Table 2-1](#) shows the 802.11n (PHY layer) throughput at different modulations.

**Table 2-1 802.11n (PHY layer) throughput at different modulations**

| Mode         | MCS | Modulation | Data Rate (Mbps) |                  |
|--------------|-----|------------|------------------|------------------|
|              |     |            | 20 MHz Channel   |                  |
| IEEE 802.11n |     |            | FGI <sup>1</sup> | SGI <sup>2</sup> |
|              | 0   | BPSK       | 6.5              | 7.2              |
|              | 1   | QPSK       | 13.0             | 14.4             |
|              | 2   | QPSK       | 19.5             | 21.7             |
|              | 3   | 16-QAM     | 26.0             | 29.9             |
|              | 4   | 16-QAM     | 39.0             | 43.3             |
|              | 5   | 64-QAM     | 52.0             | 57.8             |
|              | 6   | 64-QAM     | 58.5             | 65.0             |
|              | 7   | 64-QAM     | 65.0             | 72.2             |
|              | 8   | BPSK       | 13.0             | 14.4             |
|              | 9   | QPSK       | 26.0             | 28.9             |
|              | 10  | QPSK       | 39.0             | 43.3             |
|              | 11  | 16-QAM     | 52.0             | 57.8             |
|              | 12  | 16-QAM     | 78.0             | 86.7             |
|              | 13  | 64-QAM     | 104.0            | 115.6            |
|              | 14  | 64-QAM     | 117.0            | 130.0            |
|              | 15  | 64-QAM     | 130.0            | 144.4            |

## 2.10 Advanced WLAN features

The QCA6234 is fully compliant with IEEE 802.11e QoS, Wi-Fi Alliance® WMM Power Save, and 802.11n power saving, ensuring the lowest possible power consumption.

Advanced features such as Host wake-on-wireless and ARP (address resolution protocol) off-loading enable the WLAN link to remain associated for extended periods with host processor asleep for additional deep system power savings.

The QCA6234 features hardware-based AES, AES-CCMP, and TKIP engines for faster data encryption, and supports industry leading security features including Cisco CCXv4 ASD, WAPI (for China), WLAN Protected Setup (WPS), along with standard WEP/WPA/WPA2 for personal and enterprise environments.

<sup>1</sup> Full Guard Interval = 800 ns

<sup>2</sup> Short Guard Interval = 400 ns

Other WLAN features include:

- WWR, 802.11d, 802.11h
- WLAN Protected Setup (WPS)
- Wi-Fi CERTIFIED Wi-Fi Direct®
- RTT (Round Trip Time) for indoor locationing
- Device based scanning and roaming, tunable parameters optimized for seamless handover
- Statistics and events for monitoring
- Self-managed power state handling
- Self-contained beacon processing
- Shared authentication
- Ad-hoc power save
- Multiple PMK ID support
- Simulated UAPSD
- T-Spec support
- Production flow diagnostics
- Dynamic PS-Polling for enhanced coexistence performance with Bluetooth
- QoS support for VoIP applications
- Bluetooth 3.0 HS (High Speed) 802.11 AMP (Alternate MAC PHY)

### 2.10.1 AP mode (mobile hot spot)

The QTI industry leading AP Mode feature allows the QCA6234 device to operate as both a station and an Access Point, enabling seamless station-to-station interconnection with all the benefits of standard infrastructure-level simplicity (no special client software or settings required), security, and power save functionality. The AP Mode enables the deployment of unique and powerful applications such as mobile 3G gateway and mobile range extension.

### 2.10.2 Wi-Fi Direct (peer-to-peer)

The QTI industry leading Wi-Fi Direct implementation of advanced peer-to-peer connectivity enables faster device-to-device data and media transfer, improved network efficiency eliminating the 'hop' through the access point, simultaneous connection to device and the Internet, and simple PAN setup (with WLAN Protected Setup), all with reduced power consumption to extend battery life.

## 2.11 Host offloading (WLAN)

The QCA6234 integrates extensive hardware signal processing and an embedded on-chip CPU to offload complete 11n MAC/BB/PHY processing to minimize host processor loading and support application specific customization for gaming and mobile phones.

The QCA6234 offloads the complete 802.11 b/g/n baseband and MAC functions as a standard feature, including:

- Link maintenance
- 802.11 frame transmission sequence to initiate the connection with an access point
- Background scanning, including transmission of probe request
- Signal quality detection and automated maintenance of current access point list
- Roaming to a new access point
- Rate adaptation including automatic retry
- Encapsulation of 802.3 frames from the host to 802.11 frames, including adding the security headers for 802.11
- De-capsulation of the 802.11 frame to 802.3 frame
- Encryption and decryption (hardware ciphers) for WEP/TKIP/AES-CCMP, and WAPI
- IEEE PowerSave, periodic wakeup when in sleep mode to check for buffered traffic
- Packet Filtering and Host Wakeup, including ARP (Address Resolution Protocol) response; automated filtering of received data in the sleep mode to transfer only data packets of interest to the host
- Frame Aggregation (A-MPDU) processing
- LDPC encode/decode and STBC decode
- Additionally, the QCA6234 also provides host offloading of the following advanced features:
  - TCP checksum
  - Security negotiation: perform initial and subsequent 4-way handshake offload and initial Group Key exchange and Re-Keying

## 2.12 Advanced Bluetooth

The QCA6234 incorporates an integrated low-power Bluetooth radio, supporting all mandatory and optional features. Advanced architecture and protocol techniques, including DMA off-load, clock gating and clock scaling, and hardware-based page/inquiry scan, enable very low power operation in all states and modes.

The QCA6234, for Linux-based OS, supports all standard profiles on BlueZ stack, including (but not limited to):

- GAP: generic access profile
- SPP: serial port profile
- HSP: headset profile
- HFP: hands-free profile
- A2DP: advanced audio distribution profile
- AVRCP: audio/video remote control profile
- FTP: File transfer profile
- PAN: personal area networking profile

- OPP: object push profile
- HID: human interface device profile

The flexible RAM/ROM based architecture enables custom or future profiles to be easily added.

# 3 WLAN Functional Description

---

## 3.1 Overview

The QCA6234 WLAN block is based on the AR6004—the latest generation of the QTI 802.11n chipset optimized for low power embedded applications. It is configured to operate in dual-band, two-stream (2x2) mode.

Frame aggregation, reduced inter-frame spacing (RIFS), and half guard intervals provide improved throughput on the link. The WLAN chipset provides a robust communication environment, capable of supporting space time block codes (STBC) and Low Density Parity Check (LDPC) codes. Additional 11n performance optimizations, such as 11n frame aggregation (A-MPDU and A-MSDU) are provided by drivers that support SDIO bus transaction bundling (a form of bus aggregation) and low-overhead host assisted buffering (RX A-MSDU and RX A-MPDU).

These techniques can improve the performance and efficiency of applications involving large bulk data transfers (for example, file transfers or high-resolution video streaming). The typical data path consists of the host interface, mailbox DMA, AHB, memory controller, MAC, BB, and radio. The CPU drives the control path via register and memory accesses. External interfaces include USB LPM/HSIC, SDIO, and JTAG. See [Figure 3-1](#) for details.

## 3.2 XTENSA CPU

At the heart of the chip is the XTENSA CPU. The CPU is connected to a large 288 Kb RAM block, which precludes the need of external memory. The CPU has 512 Kb internal ROM. The CPU connects to the main AHB bus through its peripheral interface (PIF). It also has a JTAG interface for debugging.

The CPU's internal logic and boot code are designed to detect the presence of an external host and to automatically begin communicating with that host. The CPU communicates directly with the RAM and ROM modules within the device without any caching. Boot code in the 512 Kb ROM first detects the presence of an external host. It then begins communicating with this host.

### 3.3 AHB and APB blocks

The AHB block acts as an arbiter on the AHB bus and arbitrates requests from various components of the chip. Depending upon the address, the AHB data request can go into one of the two slaves: the APB block or the CPU PIF. Data requests to the CPU PIF are generally high-speed memory requests, while requests to the APB block are primarily meant for register access.

The APB block acts as a decoder. It is meant only for access to programmable registers within the AR6004's main blocks. Depending on the address, the APB request can go to one of the places listed below:

- Radio
- SI/SPI
- MBOX
- GPIO
- UART
- RTC
- MAC/BB

### 3.4 MBOX

The MBOX is a service module to handle the external SDIO host. The MBOX has two interfaces:

- an APB interface for access to the MBOX registers
- an AHB interface, which is used by the external host to access the MC memory or other registers within the AR6004

### 3.5 Debug UART

The QCA6234 includes a high-speed Universal Asynchronous Receiver/Transmitter (UART) interface that is fully compatible with the 16550 UART industry standard. This UART is a general purpose UART although it is primarily used for debug. Only the TXD is brought out to a pin, however.

### 3.6 Reset control

WLAN\_PWD\_L and BT\_PWD\_L pins need to be asserted low to completely reset both Wi-Fi and Bluetooth. After these signals have been de-asserted, the QCA6234 waits for host communication. Until then, the MAC, BB, and SOC blocks are powered off and all modules except the host interface are held in reset.

Once the host has initiated communication, the QCA6234 turns on its crystal and later its PLL. After all clocks are stable and running, the resets to all blocks are automatically de-asserted. The Bluetooth function should be powered down/reset whenever WLAN is reset because it derives its clock from WLAN.

## 3.7 Reset sequence

After a COLD\_RESET event (for example, the host toggles CHIP\_PWD\_L) the AR6004 will enter the HOST\_OFF state and await communication from the host. From that point, the typical AR6004 COLD\_RESET sequence is as follows:

1. When the host is ready to use the AR6004, it initiates communication via SDIO.
2. The AR6004 enters the WAKEUP state, then the ON state, and enables the XTENSA CPU to begin executing ROM code. Software configures the AR6004 functions and interfaces. When the AR6004 is ready to receive commands from the host, it will set an internal function ready bit.
3. The host reads the ready bit and can now send function commands to the AR6004.
4. The CPU may continue to be held in reset under some circumstances until its reset is cleared by an external pin or when the host clears a register.
5. The MAC cold reset and the MAC/BB warm reset will continue to stay asserted until their respective reset registers are cleared by software.

## 3.8 Power transition diagram

The QCA6234 provides integrated power management and control functions and extremely low power operation for maximum battery life across all operational states by:

- Gating clocks for logic when not needed
- Shutting down unneeded high speed clock sources
- Reducing voltage levels to specific blocks in some states

[Figure 3-1](#) depicts the power state transition diagram.

### 3.8.1 Hardware power states

AR6004 hardware has five top-level hardware power states managed by the RTC block. [Table 3-1](#) describes the input from the MAC, CPU, SDIO/MBOX, interrupt logic, and timers that affect the power states.

### 3.8.2 Sleep state management

Sleep state minimizes power consumption while saving system states. In SLEEP state, all high speed clocks are gated off and the external reference clock source is powered off. For the AR6004 to enter SLEEP state, the MAC, MBOX, and CPU systems must not be active.

The system remains in sleep state until a WAKEUP event causes the system to enter WAKEUP state; wait for the reference clock source to stabilize, and then ungate all enabled clock trees. The CPU wakes up only when an interrupt arrives, which may have also generated the system WAKEUP event.

**Table 3-1 Power management states**

| State    | Description                                                                                                                                                                                                                                                                                     |
|----------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| OFF      | CHIP_PWD_L pin assertion immediately brings the chip to this state.                                                                                                                                                                                                                             |
|          | Sleep clock is disabled.                                                                                                                                                                                                                                                                        |
|          | No state is preserved.                                                                                                                                                                                                                                                                          |
| HOST_OFF | WLAN is turned off. The Bluetooth clock is off, but should also be powered down through BT_PWD_L.                                                                                                                                                                                               |
|          | Only the host interface is powered on, the rest of the chip is power gated (off).                                                                                                                                                                                                               |
|          | The host instructs the AR6004 to transition to WAKEUP by writing a register in the host interface domain.                                                                                                                                                                                       |
|          | Embedded CPU and WLAN do not retain state (separate entry).                                                                                                                                                                                                                                     |
|          | For USB/HSIC or hostless designs, this state can be bypassed by asserting FORCE_HOST_ON_L during CHIP_PWD_L de-assertion.                                                                                                                                                                       |
| SLEEP    | Only the sleep clock is operating.                                                                                                                                                                                                                                                              |
|          | The crystal or oscillator is disabled.                                                                                                                                                                                                                                                          |
|          | Any wakeup events (MAC, host, LF-Timer, GPIO-interrupt) will force a transition from this state to the WAKEUP state.                                                                                                                                                                            |
|          | All internal states are maintained.                                                                                                                                                                                                                                                             |
| WAKEUP   | The system transitions from sleep states to ON.                                                                                                                                                                                                                                                 |
|          | The high frequency clock is gated off as the crystal or oscillator is brought up and the PLL is enabled.                                                                                                                                                                                        |
|          | WAKEUP duration is programmable.                                                                                                                                                                                                                                                                |
| ON       | The high speed clock is operational and sent to each block enabled by the clock control register.                                                                                                                                                                                               |
|          | Lower level clock gating is implemented at the block level, including the CPU, which can be gated off using the WAIT instruction while the system is on. No CPU, host, and WLAN activities will transition to sleep states. WLAN must be initialized prior to Bluetooth initialization and use. |

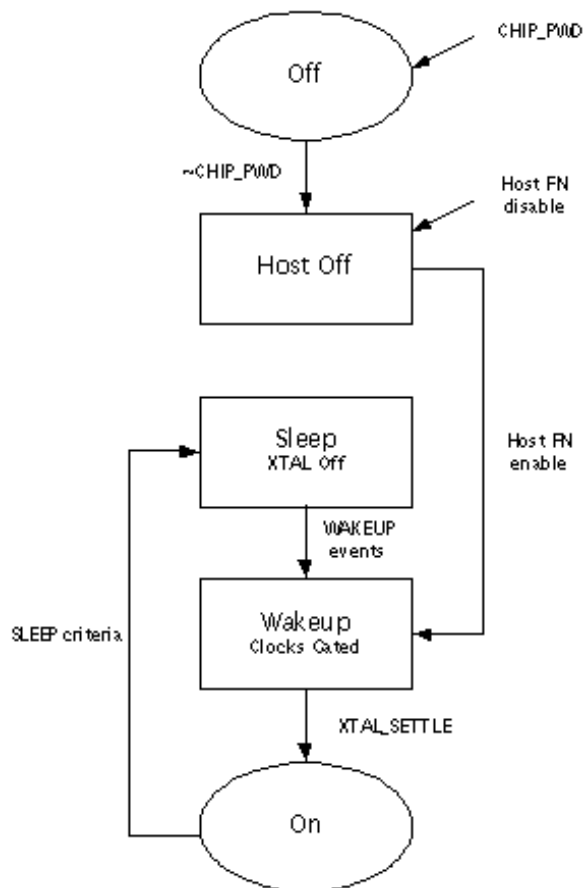


Figure 3-1 AR6004 power state

## 3.9 System clocking (RTC block)

The AR6004 has an RTC block that controls the clocks and power going to other internal modules. Its inputs consist of sleep requests from these modules and its outputs consists of clock enable and power signals, which are used to gate the clocks going to these modules. The RTC block also manages resets going to other modules with the device. The AR6004's clocking is grouped into two types: high-speed and low-speed.

### 3.9.1 High-speed clocking

The reference 26 MHz clock source inside the QCA6234 drives the PLL and RF synthesizer of Wi-Fi and Bluetooth. To minimize power consumption, the reference clock source is powered off in SLEEP, HOST\_OFF, and OFF states.

### 3.9.2 Low-speed clocking

The AR6004 has eliminated the need for an external sleep clock source, thereby reducing system cost. Instead, an internal ring oscillator is used to generate a low frequency sleep clock. It is also used to run the state machines and counters related to low power states.

The AR6004 has an internal calibration module that produces a 32.768 KHz output with minimal variation. For this, it uses the reference clock source as the golden clock. As a result, the calibration module adjusts for process and temperature variations in the ring oscillator when the system is in ON state.

The AR6004 also supports using an external low frequency sleep clock source in applications where one is already available.

### 3.9.3 Interface clock

The host interface clock represents another clock domain for the AR6004. This clock comes from the SDIO and is completely independent from the other internal clocks. It drives the host interface logic as well as certain registers, which can be accessed by the host in HOST\_OFF and SLEEP states.

## 3.10 MAC/BB/RF block

The AR6004 wireless MAC consists of five major blocks:

- Host interface unit (HIU) for bridging to the AHB for bulk data accesses and APB for register accesses
- Ten queue control units (QCU) for transferring TX data
- Ten DCF control units (DCU) for managing channel access
- Protocol control unit (PCU) for interfacing to baseband
- DMA receive unit (DRU) for transferring RX data

## 3.11 Baseband block

The AR6004 baseband module (BB) is the physical layer controller for the 802.11b/g/n air interface. It is responsible for modulating data packets in the transmit direction, and detecting and demodulating data packets in the receive direction. It has a direct control interface to the radio to enable hardware to adjust analog gains and modes dynamically.

## 3.12 Design for test

The AR6004 has a built-in JTAG boundary scan of its pins. It also has features that enable testing of digital blocks via ATPG scan, memories via MBIST, analog components, and the radio.

# 4 Bluetooth Functional Description

---

The QCA6234 Bluetooth (BT) block is based on the QTI AR3002 and described in the following sections.

## 4.1 HCI-UART interface

The UART interface is a standard high speed UART interface, being able to operate up to 4 Mbps, supporting Bluetooth HCI UART interface.

## 4.2 PCM interface

A PCM interface to an external mono-audio CODEC is supported. The BT block supports CODECs: Winbond W681360, Wolfson WM8974, and Realtek ALC5620. The PCM supports both 8 KHz/16 KHz frequencies.

The BT block can operate as the PCM interface master generating an output clock or configured as a PCM interface slave. It supports 13-bit, 16-bit, 8-bit, or 14-bit  $\mu$ -law, A-law, or linear mono-sample formats at 8K, 16K, 32K, 48K, 64K, and 96K sample(s).

## 4.3 CPU and memory

The BT block uses a 32-bit RISC core with five-stage pipelining and 16-bit and 24-bit instruction encoding. On startup, the BT block boots from the boot ROM. Software checks OTP first for configuration information. It then gets configuration from the host and proceeds to execute from on-chip ROM.

## 4.4 Standard WLAN coexistence

The QCA6234 supports internally the standard WLAN coexistence interface through the WLAN\_ACTIVE, BT\_PRIORITY, and BT\_ACTIVE pins.

## 4.5 QTI proprietary coexistence interface

The QTI proprietary interface enables increased information sharing between the Bluetooth and WLAN blocks. The interface allows the same information exchange as the on-chip interface of a single chip solution. Additional interface HW allows synchronizing the timing of the two devices. The timing synchronization and additional information enables superior WLAN and Bluetooth scheduling for increased throughput, longer range, better audio quality, and lower power consumption.

## 4.6 Reference clock

The BT block is configured for 26 MHz reference clock frequency. The clock source is provided to BT internally from the WLAN block on demand from BT\_CLK\_REQ. The WLAN block must be initialized before BT clock sharing is enabled.

## 4.7 BT low energy

The QCA6234 supports low energy specification, which allows for connection to devices with single mode LE function, for example, Watch, Sensor, and HID. The implementation is optimized for coexistence with WLAN.

## 4.8 Reset

The pin BT\_PWD\_L resets and powers down the BT block.

Holding the BT\_PWD\_L pin at GND turns off the entire BT block and all state information is lost.

All core supply voltages are internally gated off in this condition to minimize leakage.

The power-on-reset (POR) circuit detects a low-to-high transition on this pin and executes a reset after BT\_VDD has stabilized.

## 4.9 Radio

The BT radio shares the single antenna port with WLAN through an internal 3-way RF switch. The QCA6234 implements WLAN/BT coexistence internally.

BT\_VDDPA provides power to the BT PA and must be connected to the same supply voltage as BT\_VDD at 1.8 V.

## 4.10 GPIO

A single output pin BT\_LED is provided to drive an indicator LED. This pin indicates Bluetooth activity and status.

The BT\_DISABLE pin is not used and should be connected to ground.

# 5 Electrical Characteristics

## 5.1 Absolute maximum ratings

Table 5-1 summarizes the absolute maximum ratings and Table 5-2 lists the recommended operating conditions for the QCA6234. Absolute maximum ratings are those values beyond which damage to the device can occur.

Functional operation under these conditions, or at any other condition beyond those indicated in the operational sections of this document, is not recommended.

NOTE: Maximum rating for signals follows the supply domain of the signals.

**Table 5-1 Absolute maximum ratings**

| Symbol (Domain)    | Parameter                                  | Max Rating   | Unit |
|--------------------|--------------------------------------------|--------------|------|
| SDIO_IOVDD         | WLAN host interface I/O supply             | -0.3 to 4.0  | V    |
| IOVDD, BT_IOVDD    | WLAN and BT GPIO I/O power supply          | -0.3 to 4.0  | V    |
| VBAT_VDD33         | External 3.3 V power supply                | -0.3 to 4.2  | V    |
| VDD33              | External 3.3 V power supply                | -0.3 to 4.0  | V    |
| VDD33_REG          | External 3.3 V power supply                | -0.3 to 3.65 | V    |
| BT_VDD             | BT Power core supply                       | 3.6          | V    |
| BT_VDDPA           | BT PA supply                               | 3.6          | V    |
| T <sub>STORE</sub> | Storage Temperature                        | -45 to +125  | °C   |
| ANT_2G             | Maximum RF input (reference to 50-Ω input) | +10          | dBm  |
| ESD                | Electrostatic discharge tolerance          |              |      |
|                    | 5G TX1                                     | 1000         | V    |
|                    | All other pins                             | 1500         | V    |

## 5.2 Recommended operating conditions

**Table 5-2 Recommended operating conditions**

| Symbol (Domain) | Parameter                      | Min  | Typ     | Max  | Unit |
|-----------------|--------------------------------|------|---------|------|------|
| SDIO_IOVDD      | WLAN host interface I/O supply | 1.71 | 1.8/3.3 | 3.46 | V    |
| IOVDD           | WLAN GPIO I/O power supply     | 1.71 | 1.8     | 3.46 | V    |
| BT_IOVDD        | BT GPIO I/O power supply       | 1.71 | 1.8/3.3 | 3.46 | V    |
| VBAT_VDD33      | External 3.3 V power supply    | 3.14 | 3.30    | 3.46 | V    |
| VDD33           | External 3.3 V power supply    | 3.14 | 3.30    | 3.46 | V    |
| VDD33_REG       | External 3.3 V power supply    | 3.14 | 3.30    | 3.46 | V    |
| BT_VDD          | BT core supply                 | 1.71 | 1.8     | 1.98 | V    |

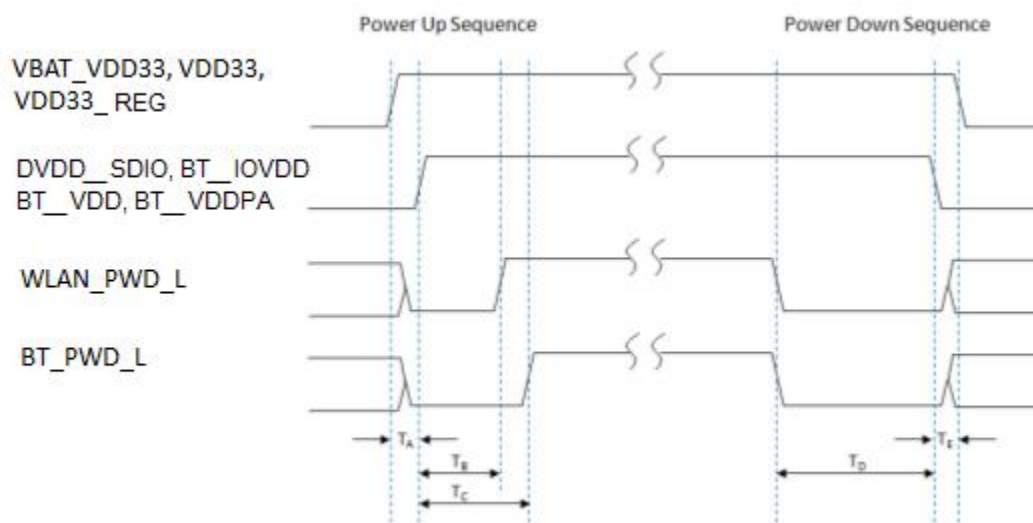
| Symbol (Domain)      | Parameter           | Min  | Typ | Max  | Unit |
|----------------------|---------------------|------|-----|------|------|
| BT_VDDPA             | BT PA supply        | 1.71 | 1.8 | 1.98 | V    |
| T <sub>ambient</sub> | Ambient temperature | -20  | 25  | 85   | °C   |

## 5.3 DC electrical characteristics

Table 5-3 lists the general DC electrical characteristics over recommended operating conditions (unless otherwise specified).

**Table 5-3 General DC electrical characteristics (for 3.3 V I/O operation)**

| Symbol          | Parameter                 |                              | Conditions                                                                          | Min                   | Typ | Max                   | Unit |
|-----------------|---------------------------|------------------------------|-------------------------------------------------------------------------------------|-----------------------|-----|-----------------------|------|
| V <sub>IH</sub> | High Level Input Voltage  |                              |                                                                                     | 0.7 x V <sub>DD</sub> |     |                       | V    |
| V <sub>IL</sub> | Low Level Input Voltage   |                              |                                                                                     |                       |     | 0.3 x V <sub>DD</sub> | V    |
| I <sub>IL</sub> | Input Leakage Current     | Without Pull-up or Pull-down | 0 V < V <sub>IN</sub> < V <sub>DD</sub><br>0 V < V <sub>OUT</sub> < V <sub>DD</sub> | 0                     |     | -3                    | nA   |
|                 |                           | With Pull-up                 | 0 V < V <sub>IN</sub> < V <sub>DD</sub><br>0 V < V <sub>OUT</sub> < V <sub>DD</sub> | 16                    |     | 48                    | μA   |
|                 |                           | With Pull-down               | 0 V < V <sub>IN</sub> < V <sub>DD</sub><br>0 V < V <sub>OUT</sub> < V <sub>DD</sub> | -14                   |     | -47                   | μA   |
| V <sub>OH</sub> | High Level Output Voltage |                              | I <sub>OH</sub> = -4mA                                                              | 0.9 x V <sub>DD</sub> |     |                       | V    |
|                 |                           |                              | I <sub>OH</sub> = -12mA                                                             | 0.9 x V <sub>DD</sub> |     |                       | V    |
| V <sub>OL</sub> | Low Level Output Voltage  |                              | I <sub>OH</sub> = 4mA                                                               |                       |     | 0.1 x V <sub>DD</sub> | V    |
|                 |                           |                              | I <sub>OH</sub> = 12mA                                                              |                       |     | 0.1 x V <sub>DD</sub> | V    |



**Figure 5-1 Power on/off timing**

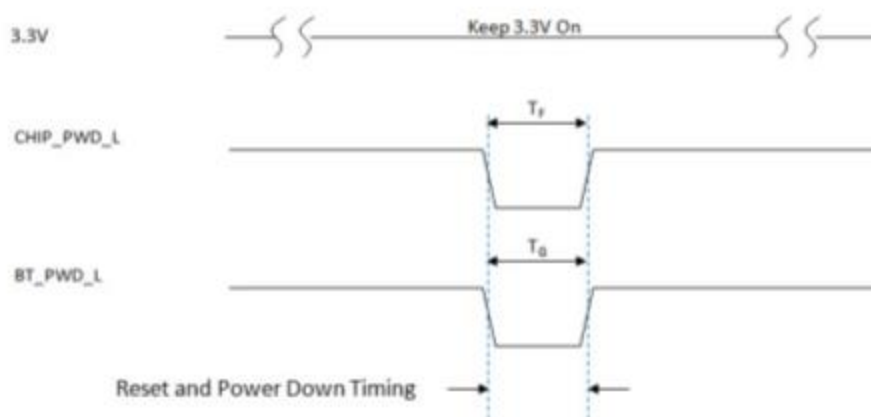


Figure 5-2 Power on/off timing

Table 5-4 Timing diagram definitions

| Timing         | Description                                                                                                                                                                                                                   | Min            | Unit |
|----------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------|------|
| T <sub>a</sub> | Time between 3.3V and VIO supplies                                                                                                                                                                                            | 0              | μsec |
| T <sub>b</sub> | Time between VIO supplies valid, SD_CMD, SD_D2, and SD_D1 SDIO lines pulled high to VIO, and WLAN_PWD_L negation.<br><br>The pull-up on SD_CMD, SD_D2, and SD_D1 configures SDIO mode on boot-up upon negation of WLAN_PWD_L. | 5              | μsec |
| T <sub>c</sub> | Time between VIO supplies valid and BT_PWD_L negation.                                                                                                                                                                        | 5              | msec |
| T <sub>d</sub> | Time between WLAN_PWD_L assertion and VIO invalid, or time between BT_PWD_L negation and VIO invalid.                                                                                                                         | 0              | μsec |
| T <sub>e</sub> | Time between VIO invalid and 3.3 V invalid.                                                                                                                                                                                   | No requirement |      |
| T <sub>f</sub> | Time of WLAN_PWD_L assertion during reset or power down period. Both 3.3 V and VIO should keep ON.                                                                                                                            | 5              | μsec |
| T <sub>g</sub> | Time of BT_PWD_L assertion during reset or power down period. Both 3.3 V and VIO should keep ON.                                                                                                                              | 5              | msec |

QCA6234 requires SDIO interface lines SD\_CMD, SD\_D1, and SD\_D2 to be high prior to negation of WLAN\_PWD\_L. Designs should drive these lines high, or if necessary, add external pull-ups to ensure proper SDIO configuration on WLAN boot-up. Failure to pull these lines high will result in non-functional SDIO interface. These are boot-mode straps interpreted by the WLAN CPU on power-on.

## 5.4 WLAN radio receiver characteristics

Table 5-5 and Table 5-7 summarize the WLAN QCA6234 receiver characteristics. VDD33 = 3.3 V and T<sub>AMBIENT</sub> = 25°C, unless otherwise specified.

**Table 5-5 WLAN receiver characteristics for 2.4 GHz dual chain operation, 25°C**

| Symbol           | Parameter                     | Conditions            | Min   | Typ | Max   | Unit |
|------------------|-------------------------------|-----------------------|-------|-----|-------|------|
| F <sub>rx</sub>  | Receive input frequency range |                       | 2.412 |     | 2.484 | GHz  |
| S <sub>rf</sub>  | Sensitivity                   |                       |       |     |       |      |
|                  | CCK, 1 Mbps                   | See Note <sup>3</sup> |       | -98 |       | dBm  |
|                  | CCK, 11 Mbps                  |                       |       | -91 |       |      |
|                  | OFDM, 6 Mbps                  |                       |       | -94 |       |      |
|                  | OFDM, 18 Mbps                 |                       |       | -90 |       |      |
|                  | OFDM, 36 Mbps                 |                       |       | -83 |       |      |
|                  | OFDM, 54 Mbps                 |                       |       | -78 |       |      |
|                  | HT20, MCS0                    |                       |       | -94 |       |      |
|                  | HT20, MCS3                    |                       |       | -86 |       |      |
|                  | HT20, MCS5                    |                       |       | -79 |       |      |
|                  | HT20, MCS7                    |                       | -74   | -76 |       |      |
|                  | HT20, MCS8                    |                       |       | -92 |       |      |
|                  | HT20, MCS11                   |                       |       | -83 |       |      |
|                  | HT20, MCS13                   |                       |       | -76 |       |      |
|                  | HT20, MCS15                   |                       |       | -72 |       |      |
| R <sub>adj</sub> | Adjacent channel rejection    |                       |       |     |       |      |
|                  | OFDM, 6 Mbps                  | See Note <sup>4</sup> |       | 32  |       | dB   |
|                  | OFDM, 54 Mbps                 |                       |       | 16  |       |      |
|                  | HT20, MCS0                    |                       |       | 31  |       |      |
|                  | HT20, MCS7                    |                       |       | 14  |       |      |

**Table 5-6 WLAN receiver characteristics for 5 GHz dual chain operation, 25°C**

| Symbol          | Parameter                     | Conditions            | Min   | Typ | Max   | Unit |
|-----------------|-------------------------------|-----------------------|-------|-----|-------|------|
| F <sub>rx</sub> | Receive input frequency range |                       | 5.180 |     | 5.925 | GHz  |
| S <sub>rf</sub> | Sensitivity                   |                       |       |     |       |      |
|                 | OFDM, 6 Mbps                  | See Note <sup>5</sup> |       | -92 |       | dBm  |
|                 | OFDM, 18 Mbps                 |                       |       | -89 |       |      |
|                 | OFDM, 36 Mbps                 |                       |       | -82 |       |      |
|                 | OFDM, 54 Mbps                 |                       |       | -76 |       |      |
|                 | HT20, MCS0                    |                       |       | -93 |       |      |
|                 | HT20, MCS3                    |                       |       | -84 |       |      |

- <sup>3</sup> Performance numbers are referenced to the QCA6234 device pin under Dual Chain Operation.
- <sup>4</sup> Performance numbers are referenced to the QCA6234 device pin under Dual Chain Operation.
- <sup>5</sup> Performance numbers are referenced to the QCA6234 device pin under Dual Chain Operation.

| Symbol | Parameter     | Conditions            | Min                        | Typ | Max | Unit |
|--------|---------------|-----------------------|----------------------------|-----|-----|------|
|        | HT20, MCS5    |                       |                            | -79 |     |      |
|        | HT20, MCS7    |                       | -70                        | -73 |     |      |
|        | HT20, MCS8    |                       |                            | -92 |     |      |
|        | HT20, MCS11   |                       |                            | -83 |     |      |
|        | HT20, MCS13   |                       |                            | -75 |     |      |
|        | HT20, MCS15   |                       |                            | -72 |     |      |
|        | HT40, MCS0    |                       |                            | -90 |     |      |
|        | HT40, MCS3    |                       |                            | -81 |     |      |
|        | HT40, MCS5    |                       |                            | -76 |     |      |
|        | HT40, MCS7    |                       |                            | -69 |     |      |
|        | HT40, MCS8    |                       |                            | -89 |     |      |
|        | HT40, MCS11   |                       |                            | -79 |     |      |
|        | HT40, MCS13   |                       |                            | -71 |     |      |
|        | HT40, MCS15   |                       |                            | -68 |     |      |
|        | Radj          |                       | Adjacent channel rejection |     |     |      |
|        | OFDM, 6 Mbps  | See Note <sup>6</sup> |                            | 22  |     | dB   |
|        | OFDM, 54 Mbps |                       |                            | 9   |     |      |
|        | HT20, MCS0    |                       |                            | 20  |     |      |
|        | HT20, MCS7    |                       |                            | 19  |     |      |

## 5.5 WLAN transmitter characteristics

Table 5-8 and Table 5-9 summarize the transmitter characteristics for QCA6234. VDD33 = 3.3 V and T<sub>AMBIENT</sub> = 25°C, unless otherwise specified.

**Table 5-7 WLAN transmitter characteristics for 2.4 GHz per chain operation, 25°C**

| Symbol           | Parameter                       | Conditions            | Min   | Typ  | Max   | Unit |
|------------------|---------------------------------|-----------------------|-------|------|-------|------|
| F <sub>tx</sub>  | Transmit output frequency range |                       | 2.412 |      | 2.484 | GHz  |
| P <sub>out</sub> | Output power                    | See Note <sup>7</sup> |       |      |       | dBm  |
|                  | 11b mask compliant              | 1 Mbps                | 17.5  | 19.0 | 20.5  |      |
|                  | 11g mask compliant              | 6 Mbps                |       | 18.0 |       |      |

<sup>6</sup> Performance numbers are referenced to the QCA6234 device pin under Dual Chain Operation.

<sup>7</sup> Performance numbers are referenced to the QCA6234 device pin under Single Chain Operation.

Dual Chain Operation will typically provide 3 dB higher output power.

Refer to IEEE Std 802.11--2012 specification for transmit spectrum limits:

- 802.11b mask (17.4.7.4)
- 802.11g mask (18.3.9.3)
- 802.11g EVM (20.3.20.7.3)
- 802.11n HT20 mask (20.3.20.1)
- 802.11n HT20 EVM (20.3.20.7.3)

| Symbol          | Parameter               | Conditions | Min  | Typ  | Max  | Unit |
|-----------------|-------------------------|------------|------|------|------|------|
|                 | 11g EVM compliant       | 54 Mbps    | 14.0 | 15.5 | 17.0 |      |
|                 | 11n HT20 mask compliant | MCS0       | 15.0 | 16.5 | 18.0 |      |
|                 | 11n HT20 EVM compliant  | MCS7       | 12.5 | 14.0 | 15.5 |      |
|                 | 11n HT20 EVM compliant  | MCS15      |      | 12.5 |      |      |
| A <sub>TX</sub> | Transmit power accuracy | -          | -    | -    | ±1.5 | dB   |

**Table 5-8 WLAN transmitter characteristics for 5 GHz per chain operation, 25°C**

| Symbol           | Parameter                       | Conditions            | Min   | Typ  | Max   | Unit |
|------------------|---------------------------------|-----------------------|-------|------|-------|------|
| F <sub>tx</sub>  | Transmit output frequency range |                       | 5.180 |      | 5.925 | GHz  |
| P <sub>out</sub> | Output power                    | See Note <sup>8</sup> |       |      |       | dBm  |
|                  | 11a mask compliant              | 6 Mbps                |       | 17   |       |      |
|                  | 11a EVM compliant               | 54 Mbps               | 11.5  | 13.5 | 15.5  |      |
|                  | 11n HT20 mask compliant         | MCS0                  | 15.5  | 17.5 | 19.5  |      |
|                  | 11n HT20 EVM compliant          | MCS7                  | 10.5  | 12.5 | 14.5  |      |
|                  | 11n HT20 EVM compliant          | MCS15                 |       | 10.5 |       |      |
|                  | 11n HT40 mask compliant         | MCS0                  |       | 14.5 |       |      |
|                  | 11n HT40 EVM compliant          | MCS7                  |       | 12.0 |       |      |
|                  | 11n HT40 EVM compliant          | MCS15                 |       | 10.5 |       |      |
| A <sub>TX</sub>  | Transmit power accuracy         | -                     | -     | -    | ±2.0  | dB   |

## 5.6 Typical WLAN power consumption performance

**Table 5-9 QCA6234 typical WLAN current consumption in SDIO mode – low power states at 3.3 V operation, T<sub>AMBIENT</sub> = 25°C**

| Mode    |          | VDD33 (mA)<br>Single Chain | DVDD_SDIO<br>(mA) | VDD33 (mA)<br>Dual Chain | DVDD_SDI<br>O (mA) |
|---------|----------|----------------------------|-------------------|--------------------------|--------------------|
| Standby | OFF      | 0.007                      | 0                 | 0.007                    | 0                  |
|         | HOST_OFF | 0.050                      | 0.04              | 0.050                    | 0.04               |
|         | SLEEP    | 0.250                      | 0.05              | 0.250                    | 0.05               |
|         | DTIM=1   | 2.28                       | 0.10              | 2.75                     | 0.10               |

<sup>8</sup> Performance numbers are referenced to the QCA6234 device pin under Single Chain Operation.

Dual Chain Operation will typically provide 3 dB higher output power.

Refer to IEEE Std 802.11--2012 specification for transmit spectrum limits:

- 802.11b mask (17.4.7.4)
- 802.11g mask (18.3.9.3)
- 802.11g EVM (20.3.20.7.3)
- 802.11n HT20 mask (20.3.20.1)
- 802.11n HT20 EVM (20.3.20.7.3)

| Mode             |         | VDD33 (mA)<br>Single Chain | DVDD_SDIO<br>(mA) | VDD33 (mA)<br>Dual Chain | DVDD_SDI<br>O (mA) |
|------------------|---------|----------------------------|-------------------|--------------------------|--------------------|
| IEEE PS, 2.4 GHz | DTIM=3  | 1.02                       | 0.08              | 1.14                     | 0.08               |
|                  | DTIM=10 | 0.52                       | 0.06              | 0.56                     | 0.06               |
| IEEE PS, 5 GHz   | DTIM=1  | 1.33                       | 0.10              | 1.43                     | 0.10               |
|                  | DTIM=3  | 0.64                       | 0.08              | 0.65                     | 0.08               |
|                  | DTIM=10 | 0.40                       | 0.06              | 0.41                     | 0.06               |

**Table 5-10 QCA6234 typical WLAN current consumption in HSIC mode – low power states at 3.3 V operation, T<sub>AMBIENT</sub> = 25°C**

| Mode             |         | VDD33 (mA)<br>Single Chain | DVDD_SDIO<br>(mA) | VDD33 (mA)<br>Dual Chain | DVDD_SDI<br>O (mA) |
|------------------|---------|----------------------------|-------------------|--------------------------|--------------------|
| Standby          | OFF     | 0.007                      | 0                 | 0.007                    | 0                  |
|                  | SLEEP   | 0.400                      | 0.05              | 0.400                    | 0.05               |
| IEEE PS, 2.4 GHz | DTIM=1  | 3.41                       | 0.10              | 3.82                     | 0.10               |
|                  | DTIM=3  | 1.46                       | 0.08              | 1.59                     | 0.08               |
|                  | DTIM=10 | 0.77                       | 0.06              | 0.81                     | 0.06               |
| IEEE PS, 5 GHz   | DTIM=1  | 1.68                       | 0.10              | 1.78                     | 0.10               |
|                  | DTIM=3  | 0.88                       | 0.08              | 0.91                     | 0.08               |
|                  | DTIM=10 | 0.60                       | 0.06              | 0.61                     | 0.06               |

**Table 5-11 Typical WLAN current consumption [2.4 GHz operation] – continuous receive at 3.3 V operation, T<sub>AMBIENT</sub> = 25°C**

| Mode/Rate [Mbps] | Typical Current Consumption<br>Single Chain (mA) <sup>9</sup> | Typical Current Consumption<br>Dual Chain (mA) <sup>10</sup> |
|------------------|---------------------------------------------------------------|--------------------------------------------------------------|
| RX, 1 Mbps       | 65                                                            | 77                                                           |
| RX, 11 Mbps      | 66                                                            | 77                                                           |
| RX, 54 Mbps      | 69                                                            | 81                                                           |
| RX, HT20 MCS0    | 67                                                            | 74                                                           |
| RX, HT20 MCS7    | 69                                                            | 83                                                           |
| RX, HT20 MCS15   | --                                                            | 88                                                           |

<sup>9</sup> With LPL enabled.

<sup>10</sup> With LPL enabled.

**Table 5-12 Typical WLAN current consumption [2.4 GHz operation] – continuous transmit at 3.3 V operation, T<sub>AMBIENT</sub> = 25°C**

| Mode/Rate [Mbps] | Output Power Per Chain [dBm] <sup>11</sup> | Typical Current Consumption Single Chain (mA) | Typical Current Consumption Dual Chain (mA) |
|------------------|--------------------------------------------|-----------------------------------------------|---------------------------------------------|
| TX, 1 Mbps       | 19.0                                       | 300                                           | 542                                         |
| TX, 6 Mbps       | 18.0                                       | 276                                           | 491                                         |
| TX, 54 Mbps      | 15.5                                       | 250                                           | 446                                         |
| TX, HT20 MCS0    | 16.5                                       | 250                                           | 446                                         |
| TX, HT20 MCS7    | 14.0                                       | 205                                           | 350                                         |

**Table 5-13 Typical WLAN current consumption [5 GHz operation] – continuous receive at 3.3 V operation, T<sub>AMBIENT</sub> = 25°C**

| Mode/Rate [Mbps] | Typical Current Consumption Single Chain (mA) | Typical Current Consumption Dual Chain (mA) |
|------------------|-----------------------------------------------|---------------------------------------------|
| RX, 54 Mbps      | 75                                            | 82                                          |
| RX, HT20 MCS0    | 79                                            | 87                                          |
| RX, HT20 MCS7    | 81                                            | 89                                          |
| RX, HT20 MCS15   | --                                            | 91                                          |
| RX, HT40 MCS0    | 91                                            | 105                                         |
| RX, HT40 MCS7    | 93                                            | 107                                         |
| RX, HT40 MCS15   | --                                            | 115                                         |

**Table 5-14 Typical WLAN current consumption [5 GHz operation] – continuous transmit at 3.3 V operation, T<sub>AMBIENT</sub> = 25°C**

| Mode/Rate [Mbps] | Output Power Per Chain [dBm] <sup>12</sup> | Typical Current Consumption Single Chain (mA) | Typical Current Consumption Dual Chain (mA) |
|------------------|--------------------------------------------|-----------------------------------------------|---------------------------------------------|
| TX, 6 Mbps       | 17.0                                       | 342                                           | 640                                         |
| TX, 54 Mbps      | 13.5                                       | 300                                           | 541                                         |
| TX, HT20 MCS0    | 17.5                                       | 343                                           | 626                                         |
| TX, HT20 MCS7    | 12.5                                       | 297                                           | 534                                         |
| TX, HT40 MCS0    | 14.5                                       | 333                                           | 604                                         |
| TX, HT40 MCS7    | 12.0                                       | 287                                           | 503                                         |

## 5.7 Bluetooth radio characteristics

Table 5-15 through Table 5-18 describe the basic rate transmitter performance, enhanced data transmitter performance, basic rate receiver performance, enhanced rate receiver performance, and current consumption conditions at 25°C.

<sup>11</sup> RF power referenced at the SiP output.

<sup>12</sup> RF power referenced at the SiP output.

**Table 5-15 Basic rate transmitter performance temperature at 25°C (1.8 V)**

| Test Parameter                                   | Min | Typ  | Max    | Bluetooth Specification              | Unit                     |
|--------------------------------------------------|-----|------|--------|--------------------------------------|--------------------------|
| RF Output Power Range                            | 4.5 | 7.5  | 10.5   |                                      | dBm                      |
| RF Power Control Range                           | 32  | 34   | 36     | $\geq 16$                            | dB                       |
| RF Power Control Step Size                       | 3   | 4    | 5      | $2 \leq \text{Step Size} \leq 8$     | dB                       |
| Frequency Range                                  | 2.4 | —    | 2.4835 | $2.4 < f < 2.4835$                   | GHz                      |
| 20 dB Bandwidth                                  | —   | 950  | —      | $\leq 1000$                          | KHz                      |
| Adjacent Channel TX Power<br>$F = F_0 \pm 2$ MHz | —   | -49  | —      | $\leq -20$                           | dBm                      |
| Adjacent Channel TX Power<br>$F = F_0 \pm 3$ MHz | —   | -50  | —      | $\leq -40$                           | dBm                      |
| $\Delta f_{1\text{avg}}$ Maximum Modulation      | —   | 164  | —      | $140 < \Delta f_{1\text{avg}} < 175$ | KHz                      |
| $\Delta f_{2\text{max}}$ Minimum Modulation      | —   | 144  | —      | $\geq 115$                           | KHz                      |
| $\Delta f_{2\text{avg}}/\Delta f_{1\text{avg}}$  | —   | 0.88 | —      | $\geq 0.80$                          | —                        |
| Initial Carrier Frequency                        | —   | 0    | —      | $\leq \pm 75$                        | KHz                      |
| Drift Rate                                       | —   | 0    | —      | $\leq 20$                            | KHz/<br>50 $\mu\text{s}$ |
| Drift (DH1 packet)                               | —   | 1    | —      | $\leq 25$                            | KHz                      |
| Drift (DH5 packet)                               | —   | -1   | —      | $\leq 40$                            | KHz                      |

**Table 5-16 Enhanced data rate transmitter performance 25°C (1.8 V)**

| Test Parameter                                   | Min                | Typ | Max   | Bluetooth Specification | Unit |
|--------------------------------------------------|--------------------|-----|-------|-------------------------|------|
| Relative Transmit Power                          | -2                 | 0   | 0.5   | -4 to +1                | dBm  |
| Max Carrier Frequency Stability<br>$ w_0 $       | $\pi/4$ DQPSK      | —   | 0     | $\leq \pm 10$           | KHz  |
|                                                  | 8 DPSK             | —   | 0     |                         |      |
| Max Carrier Frequency Stability<br>$ w_i $       | $\pi/4$ DQPSK      | —   | 0     | $\leq \pm 75$           | KHz  |
|                                                  | 8 DPSK             | —   | 0     |                         |      |
| Max Carrier Frequency Stability<br>$ w_0 + w_i $ | $\pi/4$ DQPSK      | —   | 0     | $\leq \pm 75$           | KHz  |
|                                                  | 8 DPSK             | —   | 0     |                         |      |
| RMS DEVM                                         | $\pi/4$ DQPSK      | —   | 6     | $\leq 20$               | %    |
|                                                  | 8 DPSK             | —   | 6     | $\leq 13$               | %    |
| Peak DEVM                                        | $\pi/4$ DQPSK      | —   | 16    | $\leq 35$               | %    |
|                                                  | 8 DPSK             | —   | 17    | $\leq 25$               | %    |
| 99% DEVM                                         | $\pi/4$ DQPSK      | —   | 99.9  | $99\% \leq 30$          | %    |
|                                                  | 8 DPSK             | —   | 99.9  | $99\% \leq 20$          | %    |
| EDR Differential Phase Encoding                  | —                  | 100 | —     | $\geq 99$               | %    |
| Adjacent Channel Power                           | $F \geq \pm 3$ MHz | —   | -42.5 | $< -40$                 | dBm  |
|                                                  | $F = \pm 2$ MHz    | —   | -39   | $\leq -20$              | dBm  |
|                                                  | $F = \pm 1$ MHz    | —   | -40   | $\leq -26$              | dB   |

**Table 5-17 Basic rate receiver performance at 1.8 V**

| Test Parameter                               |                                        | Min | Typ | Max | Bluetooth Specification | Unit |
|----------------------------------------------|----------------------------------------|-----|-----|-----|-------------------------|------|
| Sensitivity                                  | $BER \leq 0.1\%$                       | —   | -91 | —   | $\leq -70$              | dBm  |
| Maximum Input                                | $BER \leq 0.1\%$                       | -20 | —   | —   | $\geq -20$              | dBm  |
| Carrier-to-Interferer Ratio (C/I)            | Co-Channel                             | —   | —   | 11  | 11                      |      |
|                                              | Adjacent Channel ( $\pm 1$ MHz)        | —   | —   | 0   | 0                       | dB   |
|                                              | Second Adjacent Channel ( $\pm 2$ MHz) | —   | —   | -30 | -30                     | dB   |
|                                              | Third Adjacent Channel ( $\pm 3$ MHz)  | —   | —   | -40 | -40                     | dB   |
| Maximum Level of Intermodulation Interferers |                                        | —   | —   | -39 | $< -39$                 | dBm  |

**Table 5-18 Enhanced data rate receiver performance 1.8 V**

| Test Parameter                                  |               | Min | Typ | Max | Bluetooth Specification | Unit |
|-------------------------------------------------|---------------|-----|-----|-----|-------------------------|------|
| Sensitivity (BER $\leq 0.01\%$ )                | $\pi/4$ DQPSK | —   | -92 | —   | $\leq -70$              | dBm  |
|                                                 | 8 DPSK        | —   | -87 | —   | $\leq -70$              | dBm  |
| Maximum Input (BER $\leq 0.1\%$ )               | $\pi/4$ DQPSK | -20 | —   | —   | $\geq -20$              | dBm  |
|                                                 | 8 DPSK        | -20 | —   | —   | $\geq -20$              | dBm  |
| Co-Channel C/I (BER $\leq 0.1\%$ )              | $\pi/4$ DQPSK | —   | —   | 13  | $\leq \pm 13$           | dB   |
|                                                 | 8 DPSK        | —   | —   | 20  | $\leq \pm 20$           | dB   |
| Adjacent Channel C/I (BER $\leq 0.1\%$ )        | $\pi/4$ DQPSK | —   | —   | 0   | $\leq 0$                | dB   |
|                                                 | 8 DPSK        | —   | —   | 5   | $\leq 5$                | dB   |
| Second Adjacent Channel C/I (BER $\leq 0.1\%$ ) | $\pi/4$ DQPSK | —   | —   | -30 | $\leq -30$              | dB   |
|                                                 | 8 DPSK        | —   | —   | -25 | $\leq -25$              | dB   |
| Third Adjacent Channel C/I (BER $\leq 0.1\%$ )  | $\pi/4$ DQPSK | —   | —   | -40 | $\leq -40$              | dB   |
|                                                 | 8 DPSK        | —   | —   | -33 | $\leq -33$              | dB   |

## 5.8 Typical Bluetooth power consumption performance

**Table 5-19 Typical Bluetooth power consumption with UART interface, AR6004 in HOST\_OFF mode, BT\_VDD=1.8 V, TX=0 dBm, 25°C**

| Mode for Current Consumption | AR3002 1.8 V current (mA) | AR6004 IO current (mA) | AR6004 3.3 V current (mA) |
|------------------------------|---------------------------|------------------------|---------------------------|
| Idle Mode                    | 0.093                     | 0.05                   | 0                         |
| Inquiry Scan (1.28 sec)      | 0.485                     | 0.05                   | 0.015                     |
| Page Scan (1.28 sec)         | 0.485                     | 0.05                   | 0.015                     |
| Page and Inq Scan (1.28 sec) | 0.877                     | 0.05                   | 0.03                      |

| Mode for Current Consumption                                         | AR3002 1.8 V<br>current (mA) | AR6004 IO<br>current (mA) | AR6004 3.3 V<br>current (mA) |
|----------------------------------------------------------------------|------------------------------|---------------------------|------------------------------|
| ACL Sniff without Scan (1.28 sec Interval, 2 Attempts) <sup>13</sup> | 0.116                        | 0.05                      | 0.06                         |
| ACL Slave <sup>14</sup>                                              | 12.0                         | 0.05                      | 1.5                          |
| Inquiry                                                              | 22.0                         | 0.05                      | 1.5                          |
| DH1 Master                                                           | 25.0                         | 0.05                      | 1.5                          |
| DH1 Slave                                                            | 25.0                         | 0.05                      | 1.5                          |
| DH5 Master                                                           | 37.0                         | 0.05                      | 1.5                          |
| DH5 Slave                                                            | 34.0                         | 0.05                      | 1.5                          |
| 3DH1 Master                                                          | 29.0                         | 0.05                      | 1.5                          |
| 3DH1 Slave                                                           | 29.0                         | 0.05                      | 1.5                          |
| 3DH5 Master <sup>15</sup>                                            | 45.0                         | 0.05                      | 1.5                          |
| 3DH5 Slave <sup>16</sup>                                             | 35.0                         | 0.05                      | 1.5                          |
| HV3 Master                                                           | 17.0                         | 0.05                      | 1.5                          |
| HV3 Slave                                                            | 19.0                         | 0.05                      | 1.5                          |
| 2EV3 Master                                                          | 15.0                         | 0.05                      | 1.5                          |
| 2EV3 Slave                                                           | 17.0                         | 0.05                      | 1.5                          |
| Tx-Continuous (100% Duty Cycle) <sup>17</sup>                        | 46.0                         | 0.05                      | 1.5                          |
| Rx-Continuous (100% Duty Cycle) <sup>18</sup>                        | 42.0                         | 0.05                      | 1.5                          |

<sup>13</sup> Assuming 1 msec of correlation window.

<sup>14</sup> ACL as slave means QCA6234 is in a link (as slave) with another device, only minimum traffic to maintain link.

<sup>15</sup> 3DH5 master: QCA6234 sends a 3DH5 packet to the slave, and the slave returns a null packet.

<sup>16</sup> 3DH5 slave: QCA6234 receives a 3DH5 packet from the master and returns a null packet.

<sup>17</sup> Average power during Tx burst, 0 dBm target power, 25°C.

<sup>18</sup> Average power during Rx burst, 0 dBm target power, 25°C.

# 6 Pin Assignments and Descriptions

This chapter describes the pin assignment of the QCA6234.

The following nomenclature is used for signal description described in this chapter.

|       |                                                                      |
|-------|----------------------------------------------------------------------|
| NC    | No Connection should be made to this pin                             |
| _L    | Suffix at the end of the signal name indicating active low signal    |
| A_I/O | Analog signal                                                        |
| I     | Digital input signal                                                 |
| PU    | Weak internal pull-up, input can be left floating (not connected)    |
| PD    | Weak internal pull-down, input can be left floating (not connected)  |
| I/O   | A digital bidirectional signal                                       |
| O     | A digital output signal                                              |
| P     | A power or ground pin                                                |
| N/A   | Not applicable                                                       |
| X     | Indeterminate, floating inputs must be externally driven high or low |

| DOT | 1                        | 2                  | 3        | 4        | 5      | 6       | 7   | 8         | 9         | 10          | 11         | 12           | 13         |
|-----|--------------------------|--------------------|----------|----------|--------|---------|-----|-----------|-----------|-------------|------------|--------------|------------|
| A   | SWREG_OUT                | VDD33_PMU          | WLAN_TDO | WLAN_TMS | AVDD12 | DVDD12  | GND | IOVDD     | BT_IOVDD  | PAREG_BASE  | VBAT_VDD33 | VDD33        | VDD33      |
| B   | SWREG_OUT                | VDD33_PMU          | WLAN_TDI | WLAN_TCK | AVDD12 | DVDD12  | GND | VDD12_USB | VDD33_USB |             | PAREG_FB   | VDD33        | VDD33      |
| C   | SDIO_IOVDD               | USB_D+/HSIC_DATA   |          |          |        |         |     |           |           |             |            | GND          | GND        |
| D   | WLAN_PWD_L               | USB_D-/HSIC_STROBE |          |          |        |         |     |           |           |             |            | GND          | 2G_ANT1    |
| E   | SD_CMD                   | SD_D3              |          |          | GND    | GND     | GND | GND       | GND       |             |            | GND          | GND        |
| F   | SD_D2                    | SD_D1              |          |          | GND    | GND     | GND | GND       | GND       |             |            | GND          | 5G_ANT1    |
| G   | SD_D0                    | SD_CLK             |          |          | GND    | GND     | GND | GND       | GND       |             |            | GND          | GND        |
| H   | CLK_REQ_OUT/WCN_PRIORITY | CLK_REQ_IN         |          |          | GND    | GND     | GND | GND       | GND       |             |            | TM0          |            |
| J   | DEBUG_UART_TXD           | WAKE_ON_WLAN       |          |          | GND    | GND     | GND | GND       | GND       |             |            | TM1          | BT_VDD     |
| K   | BT_FREQ                  | WLAN_ACTIVE        |          |          |        |         |     |           |           |             |            | GND          | BT_VDDPA   |
| L   | BT_ACTIVE                | BT_PRIORITY        |          |          |        |         |     |           |           |             |            | BT_WKUP_HOST | BT_DISABLE |
| M   | GPIO10/LTE_FRAME_SYNC    | AR6004_GPIO38      | GND      | GND      | GND    | GND     | GND | PCM_SYNC  | PCM_OUT   | BT_UART_CTS | GND        | BT_UART_RXD  | BT_WKUP_BT |
| N   |                          | LTE_ACTIVE         | GND      | 2G_ANT0  | GND    | 5G_ANT0 | GND | PCM_BCLK  | PCM_IN    | BT_UART_RTS | BT_LED     | BT_UART_TXD  | BT_PWD_L   |

**Figure 6-1 QCA6234 LGA pin-out view**

Table 6-1 QCA6234 pin definitions

| Grid                       | Signal Name | Description                                                                                                   | Type | Reset State | I/O Pad Supply Domain |
|----------------------------|-------------|---------------------------------------------------------------------------------------------------------------|------|-------------|-----------------------|
| <b>Power Supplies</b>      |             |                                                                                                               |      |             |                       |
| C1                         | DVDD_SDIO   | WLAN Host IO (SDIO) power supply input; 1.8 V                                                                 | P    | N/A         | N/A                   |
| A8                         | IOVDD       | WLAN VIO power supply input; 1.8 V                                                                            | P    | N/A         | N/A                   |
| A11                        | VBAT_VDD33  | WLAN VBAT supply input. Connect to 3.3 V.                                                                     | P    | N/A         | N/A                   |
| A10                        | PAREG_BASE  | PAREG gate control output.                                                                                    | O    | N/A         | N/A                   |
| B11                        | PAREG_FB    | Signal should be connected to 3.3 V output of external pass transistor when using PAREG.                      | P    | N/A         | N/A                   |
| A12,A13,<br>B12,B13        | VDD33       | WLAN 3.3 V power supply input to WLAN PA.                                                                     | P    | N/A         | N/A                   |
| A1,B1                      | SWREG_OUT   | On-chip 1.2V switching regulator inductor.<br>No connect for USB version (6234XU)                             | P    | N/A         | N/A                   |
| A6,B6                      | DVDD12      | WLAN internal digital 1.2 V input fed from switching regulator filter.                                        | P    | N/A         | N/A                   |
| A5,B5                      | AVDD12      | WLAN internal analog 1.2 V input fed from switching regulator filter.                                         | P    | N/A         | N/A                   |
| A2,B2                      | VDD33_REG   | WLAN 3.3 V power supply input to on-chip 1.2 V switching regulator.                                           | P    | N/A         | N/A                   |
| J13                        | BT_VDD      | BT core power supply input. 1.8 V. Must be same as BT_IOVDD.                                                  | P    | N/A         | N/A                   |
| K13                        | BT_VDDPA    | Power supply for BT PA. Must be same as BT_IOVDD.                                                             | P    | N/A         | N/A                   |
| A9                         | BT_IOVDD    | BT VIO power supply input. Must be same voltage as IOVDD due to internal interconnection between WLAN and BT. | P    | N/A         | N/A                   |
| B8                         | VDD12_USB   | Serial interface 1.2 V input fed from switching regulator filter.                                             | P    | N/A         | N/A                   |
| B9                         | VDD33_USB   | Serial interface 3.3 V input. Connect to 3.3 V.                                                               | P    | N/A         | N/A                   |
| See pin-out                | GND         | Ground                                                                                                        | P    | N/A         | N/A                   |
| <b>WLAN Host Interface</b> |             |                                                                                                               |      |             |                       |
| G2                         | SD_CLK      | SDIO Clock signal                                                                                             | I    | Hi-Z        | SDIO_IOVDD            |

| Grid                             | Signal Name  | Description                                                                                                                                                             | Type    | Reset State | I/O Pad Supply Domain |
|----------------------------------|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|-------------|-----------------------|
| E1                               | SD_CMD       | SDIO Command signal, must be pulled externally high prior to WLAN_PWD_L negation to boot properly in SDIO mode                                                          | I/O     |             | SDIO_IOVDD            |
| G1                               | SD_D0        | SDIO Data[0]                                                                                                                                                            | I/O     |             | SDIO_IOVDD            |
| F2                               | SD_D1        | SDIO Data[1], must be pulled externally high prior to WLAN_PWD_L negation to boot properly in SDIO mode                                                                 | I/O     |             | SDIO_IOVDD            |
| F1                               | SD_D2        | SDIO Data[2] signal, must be pulled high prior to WLAN_PWD_L negation to boot properly in SDIO mode                                                                     | I/O     |             | SDIO_IOVDD            |
| E2                               | SD_D3        | SDIO Data[3] signal                                                                                                                                                     | I/O     |             | SDIO_IOVDD            |
| D1                               | WLAN_PWD_L   | WLAN Power Down (0=power down, 1=WLAN awake). Negation samples boot strap pins for SDIO interface mode.                                                                 | I, PD   | Low         | SDIO_IOVDD            |
| J2                               | GPIO9        | GPIO pin, typically used as Wake-On-Wireless (WOW): WLAN output signal to wake up host, active high.                                                                    | I/O, PD | Low         | IOVDD                 |
| C2                               | USB_D_POS    | High speed serial interface, positive input for USB 2.0 mode. Also data line for HSIC mode.                                                                             | I/O     |             | USB/HSIC              |
| D2                               | USB_D_NEG    | High speed serial interface, negative input for USB 2.0 mode. Also strobe line for HSIC mode.                                                                           | I/O     |             | USB/HSIC              |
| <b>BT Host Control Interface</b> |              |                                                                                                                                                                         |         |             |                       |
| N13                              | BT_PWD_L     | BT Chip power-down control; driving this pin active low powers down or resets the BT. Signal has internal weak pull-up. BT_PWD_L should be active low at least for 5ms. | I, PU   | High        | BT_IOVDD              |
| M13                              | BT_HOST_WKUP | Host wake-up BT.                                                                                                                                                        | I       | High        | BT_IOVDD              |
| L12                              | BT_WKUP_HOST | BT wake-up host.                                                                                                                                                        | O       | High        | BT_IOVDD              |
| N11                              | BT_LED       | BT GPIO pin: SW can be re-configured for BT_LED.                                                                                                                        | O, PU   | High        | BT_IOVDD              |
| L13                              | BT_DISABLE   | This pin is not used. Connect to ground.                                                                                                                                |         |             |                       |
| <b>BT UART Interface</b>         |              |                                                                                                                                                                         |         |             |                       |
| N10                              | UART_RTS     | BT UART Request-To-Send. High during reset, Low after Reset. Internal pull-down.                                                                                        | O       | High        | BT_IOVDD              |

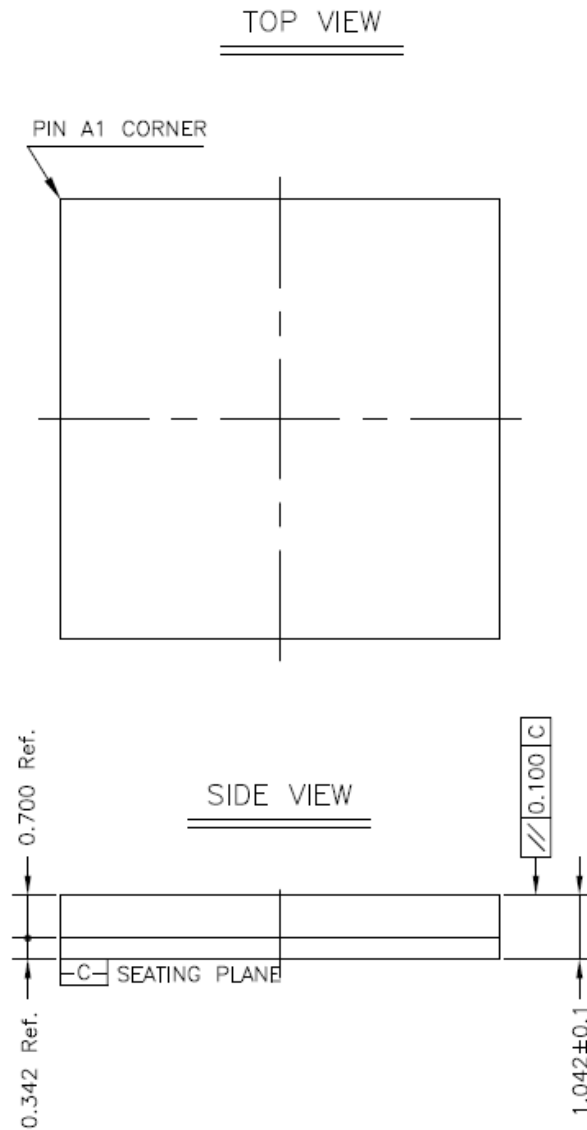
| Grid                           | Signal Name    | Description                                                                                                        | Type    | Reset State | I/O Pad Supply Domain |
|--------------------------------|----------------|--------------------------------------------------------------------------------------------------------------------|---------|-------------|-----------------------|
| M12                            | UART_RXD       | BT UART receive data. Signal goes low during reset, Tri-state after reset.                                         | I       | Low         | BT_IOVDD              |
| M10                            | UART_CTS       | BT UART Clear-To-Send.                                                                                             | I       | High        | BT_IOVDD              |
| N12                            | UART_TXD       | BT UART Transmit Data                                                                                              | O, PU   | High        | BT_IOVDD              |
| <b>BT PCM Interface</b>        |                |                                                                                                                    |         |             |                       |
| N9                             | PCM_IN         | CODEC interface Input data. High on Reset, Low after reset. Weak pull-down.                                        | I, PD   | Low         | BT_IOVDD              |
| M9                             | PCM_OUT        | CODEC interface Output data. High on Reset, Low after reset.                                                       | O, PD   | Low         | BT_IOVDD              |
| M8                             | PCM_SYNC       | CODEC interface synchronization control, input for slave, output for master. High on Reset, Low after reset.       | I/O, PD | Low         | BT_IOVDD              |
| N8                             | PCM_BCK        | CODEC interface bit clock, input for slave, output for master. High on Reset, Low after reset.                     | I/O, PD | Low         | BT_IOVDD              |
| <b>WLAN/BT Debugging</b>       |                |                                                                                                                    |         |             |                       |
| J1                             | DEBUG_UART_TXD | WLAN debugging UART TXD (GPIO11)                                                                                   | O       | High        | IOVDD                 |
| K1                             | BT_FREQ        | Internal WLAN/BT coex control lines, test observability only; do not connect or use. Can be configured as BT JTAG. |         |             |                       |
| K2                             | WLAN_ACTIVE    | Internal WLAN/BT coex control lines, test observability only; do not connect or use. Can be configured as BT JTAG. |         |             |                       |
| L1                             | BT_ACTIVE      | Internal WLAN/BT coex control lines, test observability only; do not connect or use. Can be configured as BT JTAG. |         |             |                       |
| L2                             | BT_PRIOR       | Internal WLAN/BT coex control lines, test observability only; do not connect or use. Can be configured as BT JTAG. |         |             |                       |
| M1                             | GPIO10         | WLAN GPIO 10                                                                                                       | I,PU    | High        | IOVDD                 |
| <b>RF Interface - RF ports</b> |                |                                                                                                                    |         |             |                       |
| N4                             | 2G_ANT0        | WLAN/RF 2.4 GHz Antenna Port for chain 1                                                                           | A_I/O   | N/A         | N/A                   |
| N6                             | 5G_ANT0        | WLAN/RF 5 GHz Antenna Port for chain 1                                                                             | A_I/O   | N/A         | N/A                   |
| D13                            | 2G_ANT1        | WLAN/RF 2.4 GHz Antenna Port for chain 2                                                                           | A_I/O   | N/A         | N/A                   |
| F13                            | 5G_ANT1        | WLAN/RF 5 GHz Antenna Port for chain 2                                                                             | A_I/O   | N/A         | N/A                   |

| Grid                      | Signal Name | Description                                                                                                                                         | Type  | Reset State | I/O Pad Supply Domain |
|---------------------------|-------------|-----------------------------------------------------------------------------------------------------------------------------------------------------|-------|-------------|-----------------------|
| <b>Clock - BT Clock</b>   |             |                                                                                                                                                     |       |             |                       |
| H2                        | GPIO7       | Internal BT Clock Request signal. It has internal connection from BT to WLAN GPIO7. Do not use this pin, leave as No connect. Useful only for test. | I/O   | Low         | IOVDD                 |
| H1                        | GPIO37      | LTE co-existence signal WCN_PRIORITY.                                                                                                               | O, PU | High        | IOVDD                 |
| <b>BT Loopback</b>        |             |                                                                                                                                                     |       |             |                       |
| H12                       | BT_TM0      | Bluetooth test mode. Do not connect.                                                                                                                |       |             |                       |
| J12                       | BT_TM1      | Bluetooth test mode. Do not connect.                                                                                                                |       |             |                       |
| <b>WLAN Boundary Scan</b> |             |                                                                                                                                                     |       |             |                       |
| A4                        | WLAN_TMS    | No Connect (NC)                                                                                                                                     |       |             |                       |
| B4                        | WLAN_TCK    | No Connect (NC)                                                                                                                                     |       |             |                       |
| B3                        | WLAN_TDI    | No Connect (NC)                                                                                                                                     |       |             |                       |
| A3                        | WLAN_TDO    | No Connect (NC)                                                                                                                                     |       |             |                       |
| <b>LTE Co-existence</b>   |             |                                                                                                                                                     |       |             |                       |
| N2                        | GPIO36      | LTE co-existence signal LTE_ACTIVE                                                                                                                  |       |             |                       |
| N1                        | GPIO35      | LTE co-existence signal LTE_FRAME_SYNC                                                                                                              |       |             |                       |
| M2                        | GPIO38      | Reserved                                                                                                                                            |       |             |                       |

# 7 Package Dimensions

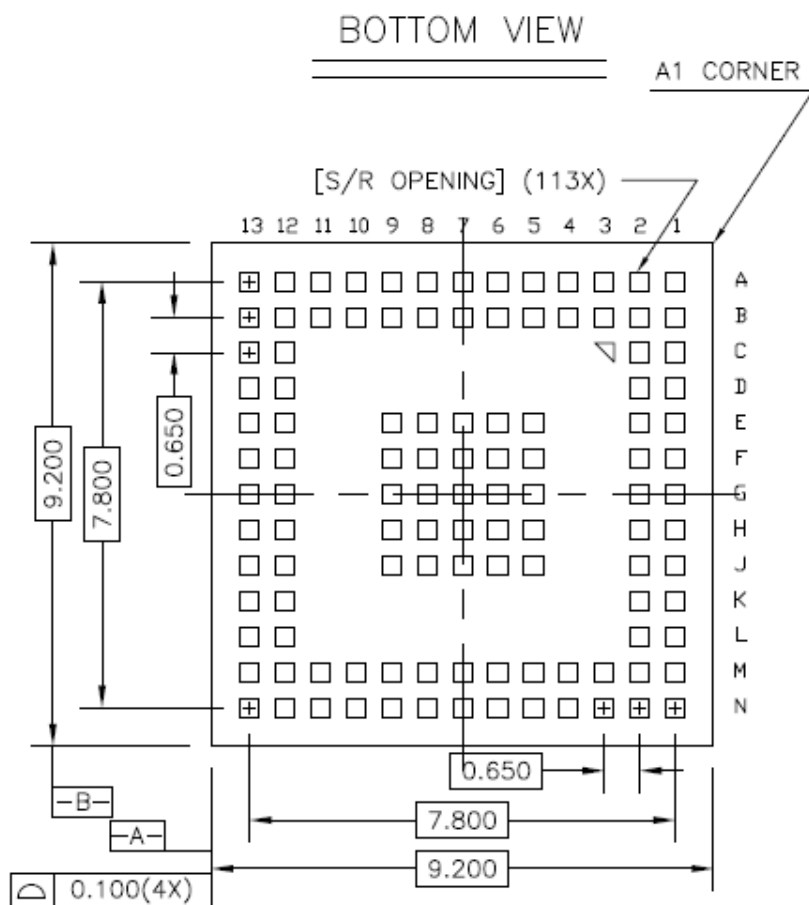
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Figure 7-1 shows the top and side views of QCA6234 (with height).



**Figure 7-1 QCA6234 package top and side views**

Figure 7-2 shows the bottom view of QCA6234 (with x-y dimensions).



|               |
|---------------|
| Lead Pitch:   |
| 0.650         |
| Lead Size:    |
| 0.350 x 0.350 |

Dimensions in mm.

**Figure 7-2 QCA6234 bottom view**

## 8 Ordering Information

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This product can be ordered as:

- SDIO interface version:
  - QCA6234X-AM2D
  - QCA6234X-AM2D-R (Tape and Reel, Qty = 2Ku)
  - QCA6234XW-AM2D\*
  - QCA6234XW-AM2D-R\* (Tape and Reel, Qty = 2Ku)
  - QCA6234X2-AM2D\*
  - QCA6234X2-AM2D-R\* (Tape and Reel, Qty = 2Ku)
- HSIC interface version:
  - QCA6234XH-AM2D
  - QCA6234XH-AM2D-R (Tape and Reel, Qty = 2Ku)
- USB interface version
  - QCA6234XU-AM2D
  - QCA6234XU-AM2D-R (Tape and Reel, Qty = 2Ku)

\* Contact your local QTI representative for availability.

## 9 Part Reliability Summary

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**Table 9-1 QCA6234 device reliability test results**

| Tests, Standards, and Conditions                                                                                   | Sample Size | Result                                                                   |
|--------------------------------------------------------------------------------------------------------------------|-------------|--------------------------------------------------------------------------|
| <b>ESD – Human-body model (HBM) rating</b><br>JESD22-A114<br>Target: 2000 V.<br>(Total samples from one wafer lot) | 1x3         | $\pm 1.5\text{KV}$ PASS all pins,<br>Except 5G Tx1 pass $\pm 1\text{KV}$ |
| <b>ESD – Charge-device model (CDM) rating</b> JESD22-C101<br>Target: 500 V<br>(Total samples from one wafer lot)   | 1x3         | $\pm 500\text{V}$ PASS                                                   |

**Table 9-2 QCA6234 package reliability test results**

| Tests, Standards, and Conditions                                                                                                                                                                             | Sample Size | Result |
|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------|--------|
| <b>Preconditioning:</b><br>J-STD-020, JESD22-A113<br>MSL 1, reflow temperature: $260\text{C}+0/-5^{\circ}\text{C}$<br>(Total samples from three different assembly lots)                                     | 3x154       | PASS   |
| <b>Temperature cycle:</b> (after Preconditioning)<br>JESD22-A104<br>$-55^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ ; 1000 cycles<br>2 cycles per hour<br>(Total samples from three different assembly lots) | 3x77        | PASS   |
| <b>Unbiased Highly accelerated stress test (uHAST):</b> (after Preconditioning)<br>JESD22-A118, JESD22-A113<br>cond. A, $130\text{C}$ , 96 hours<br>(Total samples from three different assembly lots)       | 3x77        | PASS   |
| <b>High-Temperature Storage Life:</b><br>JESD22-A103<br>Temperature $150^{\circ}\text{C}$ , 1000 hours duration<br>(Total samples from three different assembly lots)                                        | 3x77        | PASS   |

# 10 Carriage, Storage & Handling Information

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This chapter describes career tape system, tape and reel, and storage requirements for the QCA6234. See [Table 10-1](#).

## 10.1 10.1 Carrier Tape System

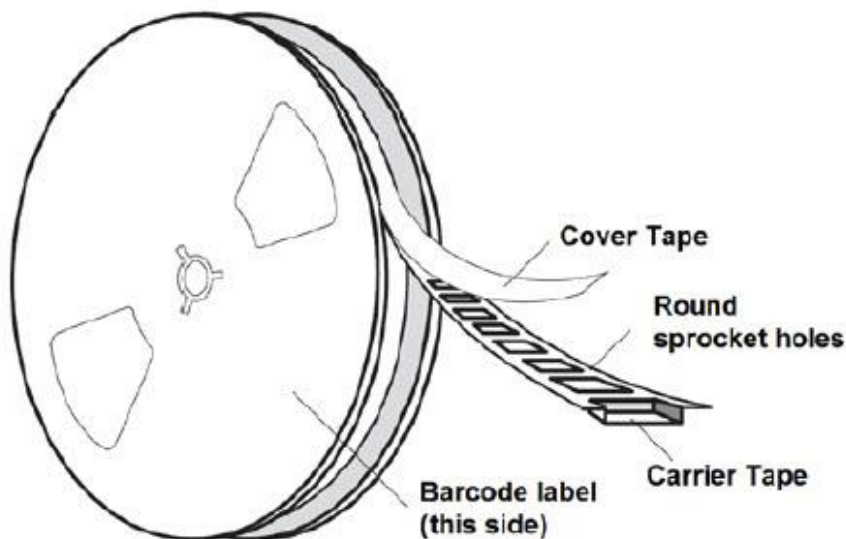
**Table 10-1 Reel and Protective Band Attributes**

| Units per Reel | Tape Width | Tape Pitch | Reel Diameter | Hub Diameter |
|----------------|------------|------------|---------------|--------------|
| 2000           | 24 mm      | 12 mm      | 330 mm        | 178 mm       |

### 10.1.1 Tape and Reel Information

The single-feed carrier for the QCA6234 device is illustrated in [Figure 10-1](#) which shows the tape orientation on reel. [Figure 10-2](#) shows the part orientation on tape.

The carrier tape and reel features comply to the EIA-481 standard.



**Figure 10-1 Tape Orientation on Reel**

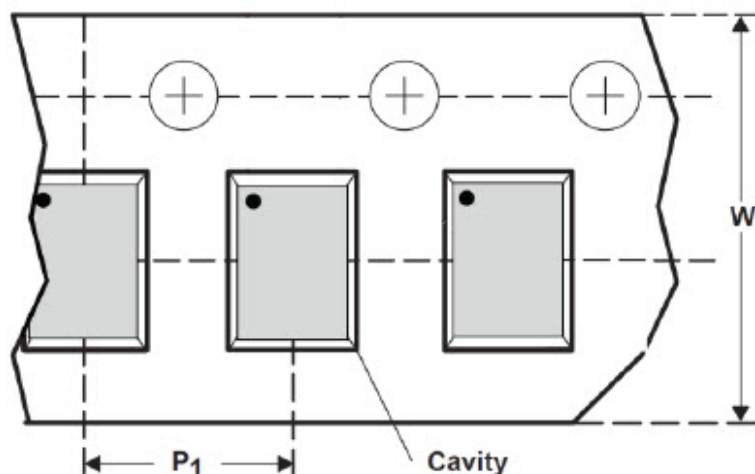


Figure 10-2 Device Orientation in Tape: Left/Q1

## 10.2 Storage

### 10.2.1 Bag storage conditions

The packages described in this document must be stored in a nitrogen-purged, sealed moisture barrier antistatic bag. The Qualcomm-calculated shelf life in a sealed moisture bag is 60 months at  $< 40^{\circ}\text{C}$  and  $< 90\%$  relative humidity (RH). Qualcomm recommends the following shipping and storage conditions for the CSP reel inside the sealed bag:

- Relative humidity between 15% and 70%
- Temperature – Room temperature lower than  $30^{\circ}\text{C}$
- Atmosphere – A nitrogen dry cabinet is highly preferred

Devices should not be baked in tapes and reels at the temperatures described in this section, or at any other temperatures.

### 10.2.2 Out of Bag Duration

After unpacking, the package must be soldered to the PCB within the factory floor life according to the MSL rating when factory conditions are  $< 30^{\circ}\text{C}$  and  $< 60\%$  RH, as specified in the *IPC/JEDEC-STD-033* standard.

## 10.3 Handling

In addition to the storage guidelines described above, the following handling guidelines should be followed.

To eliminate damage to the silicon die due to improper handling, the following recommendations should be followed:

- Do not use tweezers, as that may cause damage to the silicon die. Qualcomm recommends using a vacuum tip to handle the device.

- Carefully select a pickup tool to avoid any damage during the SMT process.
- Do not make contact with the device when reworking or tuning components that are in close proximity to the device.

### 10.3.1 Baking

It is not necessary to bake the QCA6234 if the conditions specified in [Section 10.2](#) have not been exceeded.

It is necessary to bake the QCA6234 if any condition specified in [Section 10.2](#) has been exceeded. The baking conditions are specified on the moisture-sensitive caution label attached to each bag.

**CAUTION:** If baking is required, the devices must be transferred into trays that can be baked to at least 125°C. Devices should not be baked in tape and reel carriers at any temperature.

### 10.3.2 Electrostatic Discharge

Electrostatic discharge (ESD) occurs naturally in laboratory and factory environments. An established high-voltage potential is always at risk of discharging to a lower potential. If this discharge path is through a semiconductor device, destructive damage may result.

ESD countermeasures and handling methods must be developed and used to control the factory environment at each manufacturing site.

QTI products must be handled according to the *ESD Association standard: ANSI/ESD S20.20-1999, Protection of Electrical and Electronic Parts, Assemblies, and Equipment*.

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